

# **Film Capacitors**

# Metallized Polyester Film Capacitors (MKT)

 Series/Type:
 B32227

 Date:
 May 2009

© EPCOS AG 2009. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.



Metallized polyester film capacitors (MKT)

- Test and measurement equipment
- Laser, ultrasonic, X-ray, microwave

# Climatic

- Max. operating temperature: 85 °C
- Climatic category (IEC 60068-1): 40/085/21

# Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Flat winding
- Insulating sleeve
- Face ends sealed with epoxy resin

# Terminals

Central axial wire leads, lead-free tinned

### Marking

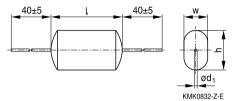
Manufacturer's logo,

style (MKT), series number, rated capacitance, capacitance tolerance (code letter), rated DC voltage, date of manufacture (coded)

#### **Delivery mode**

Bulk (untaped)

## **Dimensional drawing**



Dimensions in mm

Width w <sub>max</sub>	≤6.0	8 10	≥10.5
Lead diameter d <sub>1</sub>	0.6	0.8	1.0

When bending leads take care to leave a clearance of 1 mm to the capacitor body.



B32227



High voltage (wound)

# Overview of available types

Туре	B32227		
Page	4		
V <sub>R</sub> (V DC)	2500	4000	6300
V <sub>RMS</sub> (V AC)	220	220	220
C <sub>R</sub> (μF)			
0.010			
0.025			
0.05			
0.10			
0.25			



− μ MKT

B32227

High voltage (wound)

# Ordering codes and packing units

V <sub>R</sub>	V <sub>RMS</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Untaped
	f ≤60 Hz		$w \times h \times I$	(composition see	
V DC	V AC	μF	mm	below)	pcs./MOQ
2500	220	0.025	$8.5 \times 18.0 \times 33.0$	B32227J2253M000	200
		0.050	$12.5\times25.5\times33.0$	B32227J2503M000	200
		0.10	$10.5 \times 26.5 \times 45.0$	B32227J2104M000	80
		0.25	$15.5 \times 40.5 \times 45.0$	B32227J2254M000	80
4000	220	0.010	$9.5 \times 22.0 \times 33.0$	B32227J4103M000	80
		0.025	$10.0 \times 22.5 \times 45.0$	B32227J4253M000	80
		0.050	$12.5\times31.0\times45.0$	B32227J4503M000	80
		0.10	$16.5 \times 42.0 \times 45.0$	B32227J4104M000	80
6300	220	0.010	$9.0 \times 21.5 \times 45.0$	B32227J6103M000	80
		0.025	$13.5\times32.5\times45.0$	B32227J6253M000	80
		0.050	$17.0\times42.0\times45.0$	B32227J6503M000	80

MOQ = Minimum Order Quantity, consisting of 4 packing units.

#### Composition of ordering code

Capacitance tolerance code:  $M = \pm 20\%$ 



B32227

High voltage (wound)

	ь
	ž
	4
Ĩ	

# Technical data

	1				
Operating temperature range	Max. operating temperature T <sub>op,max</sub> +85 °C				
		gory temperature T <sub>max</sub>	+85 °C		
	Lower cate	gory temperature T <sub>min</sub>	−40 °C		
	Rated temp	erature T <sub>R</sub>	+85 °C		
Dissipation factor tan $\delta$ (in 10 <sup>-3</sup> )	at 1 kHz: 8				
at 20 °C	at 10 kHz: 15				
(upper limit values)					
Insulation resistance R <sub>ins</sub>	$30\ 000\ \text{M}\Omega$				
at 20 °C, rel. humidity $\leq$ 65%					
(minimum as-delivered values)					
DC test voltage	1.2 · V <sub>R</sub> , 2 s	3			
Category voltage V <sub>c</sub>	T <sub>A</sub> (°C)	DC voltage derating	AC voltage derating		
(continuous operation with $V_{\text{DC}}$	$T_A \leq 70$	$V_{\rm C} = V_{\rm R}$	$V_{C,RMS} = V_{RMS}$		
or $V_{AC}$ at f $\leq$ 60 Hz)	70 <t<sub>A ≤85</t<sub>	$V_{C} = V_{R} \cdot 0.55$	$V_{C,RMS} = V_{RMS} \cdot 0.70$		
Damp heat test	21 days/40	°C/93% relative humidity	/		
Limit values after damp	Capacitanc	e change  ∆C/C	$\leq$ 3% (for C <sub>R</sub> > 0.1 $\mu$ F)		
heat test			$\leq$ 5% (for C <sub>R</sub> $\leq$ 0.1 $\mu$ F)		
	Dissipation factor change $\Delta$ tan $\delta$		≤ 3 · 10 <sup>.</sup> 3 (at 1 kHz)		
			≤ 5 · 10 <sup>.</sup> 3 (at 10 kHz)		
	Insulation re	esistance R <sub>ins</sub>	≥ 20% of minimum		
			as-delivered values		
Reliability:					
Failure rate $\lambda$	10 fit (≤ 10	• 10 <sup>-9</sup> /h) at 0.5 • V <sub>R</sub> , 40 °	D°		
Service life t <sub>SL</sub>	200 000 h a	at 1.0 · V <sub>R</sub> , 40 °C			
	For convers	sion to other operating co	onditions and temperatures,		
	refer to cha	pter "Quality, 2 Reliabilit	у".		
Failure criteria:					
Total failure	Short circuit	t or open circuit			
Failure due to variation	Capacitanc	e change  ∆C/C	> 10%		
of parameters	Dissipation	factor tan $\delta$	> 2 · upper limit value		
	Insulation re	esistance R <sub>ins</sub>	< 150 MΩ		





High voltage (wound)

#### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in  $V/\mu s$ .

 $"k_0"$  represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in  $V^2/\mu s.$ 

Note:

The values of dV/dt and  $k_0$  provided below must not be exceeded in order to avoid damaging the capacitor.

#### dV/dt values

Length of c	apacitor	33 mm	45 mm
V <sub>R</sub>	V <sub>RMS</sub>		
V DC	V AC	dV/dt in V/μs	
2500	220	25	12.5
4000	220	40	20
6300	220	_	40

#### k<sub>0</sub> values

Length of c	apacitor	33 mm	45 mm
V <sub>R</sub>	V <sub>RMS</sub>		
V DC	V AC	k₀ in V²/μs	
2500	220	125 000	62 500
4000	220	320 000	160 000
6300	220	_	500 000

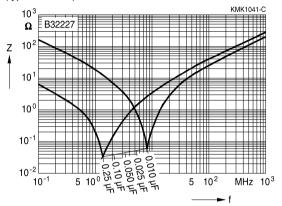


4 MKT

High voltage (wound)

#### Impedance Z versus frequency f

(typical values)



## Permissible AC voltage $V_{\mbox{\tiny RMS}}$ versus frequency f

Values can be obtained on request. In specific cases please provide a scaled voltage/ time graph and state operating conditions.



#### Mounting guidelines

#### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ $-0.5$ mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder $\ge$ 90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

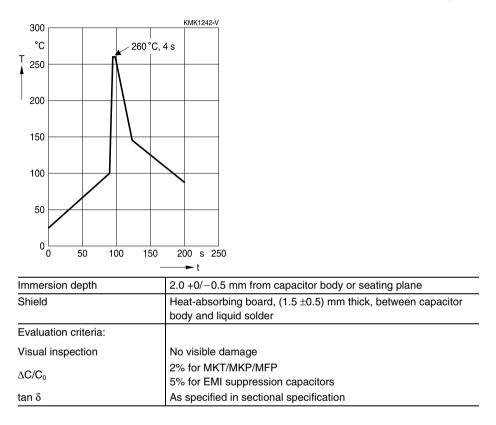
Series		Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing $\leq$ 7.5 mm) uncoated (lead spacing $\leq$ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing $\leq$ 10 mm) and insulated (B32559)





#### High voltage (wound)

B32227





#### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### **Uncoated capacitors**

For uncoated MKT capacitors with lead spacings  $\leq$ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



# → 4 MKT

High voltage (wound)

## 2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Туре	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70  $^{\circ}$ C) before they are subjected to subsequent electrical testing.

#### Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro- ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

#### Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



#### 3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100  $^{\circ}$ C.

#### Caution:

Consult us first if you wish to embed uncoated types!





#### High voltage (wound)

#### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





High voltage (wound)

Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



B32227

− ∮ MKT −

High voltage (wound)

# Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_{c}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
βc	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C <sub>R</sub>	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
F <sub>D</sub>	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F <sub>τ</sub>	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





High voltage (wound)

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i <sub>z</sub>	Capacitance drift	Inkonstanz der Kapazität
k <sub>o</sub>	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
Ri	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R <sub>P</sub>	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan  \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ <sub>₽</sub>	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$\tan \delta_{s}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T₄	Ambient temperature	Umgebungstemperatur
T <sub>max</sub>	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
toL	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
52	and voltage	-spannung
Top	Operating temperature	Beriebstemperatur
T <sub>B</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer
V <sub>AC</sub>	AC voltage	Wechselspannung



B32227

H AMKT

High voltage (wound)

Symbol	English	German
Vc	Category voltage	Kategoriespannung
V <sub>C,RMS</sub>	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{\text{DC}}$	DC voltage	Gleichspannung
$V_{\text{FB}}$	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V <sub>op</sub>	Operating voltage	Betriebsspannung
V <sub>p</sub>	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
V <sub>R</sub>	Rated voltage	Nennspannung
ν̂ <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{\text{RMS}}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
$V_{sc}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{\rm sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CSMP, CSSP, CTVS, DSSP, MiniBlue, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.